


1732

AMENDMENT TRANSMITTAL LETTER (Large Entity)				Docket No. SKI.007D	
Applicant(s): Hiroiyuki Nishi et al.					
Serial No. 09/893,455	APR 03 2003	Filing Date June 29, 2001	Examiner A. Ortiz	Group Art Unit 1732	
Invention: TRANSFER MOLDING APPARATUS AND METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICES					
<u>TO THE ASSISTANT COMMISSIONER FOR PATENTS:</u>					
Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.					
CLAIMS AS AMENDED					
	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	6 -	20 =	0 x	\$18.00	\$0.00
INDEP. CLAIMS	2 -	3 =	0 x	\$84.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00
<div style="display: flex; justify-content: space-between;"><div><p><input checked="" type="checkbox"/> No additional fee is required for amendment.</p><p><input type="checkbox"/> Please charge Deposit Account No. _____ in the amount of _____ A duplicate copy of this sheet is enclosed.</p><p><input type="checkbox"/> A check in the amount of _____ to cover the filing fee is enclosed.</p><p><input checked="" type="checkbox"/> The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 50-0238 A duplicate copy of this sheet is enclosed.</p><p><input checked="" type="checkbox"/> Any additional filing fees required under 37 C.F.R. 1.16.</p><p><input checked="" type="checkbox"/> Any patent application processing fees under 37 CFR 1.17.</p></div><div style="text-align: right;"><p>Dated: April 3, 2003</p></div></div> <div style="margin-top: 20px;"><div style="display: flex; justify-content: space-between;"><div style="width: 45%;"><p> Signature</p><p>ANDREW J. TELESZ, JR. REG. NO. 33,581</p><p>VOLENTINE FRANCOS, P.L.L.C. 12200 SUNRISE VALLEY DRIVE, SUITE 150 RESTON, VA 20191</p><p>TEL. NO. (703) 715-0870</p></div><div style="width: 50%; border: 1px solid black; padding: 5px;"><p>I certify that this document and fee is being deposited on _____ with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.</p><p style="text-align: center;">_____ Signature of Person Mailing Correspondence</p><p style="text-align: center;">_____ Typed or Printed Name of Person Mailing Correspondence</p></div></div></div>					
CC:					

RECEIVED
APR 07 2003
GROUP 1700



#4/B
1.6.7
4-703

SKI.007D

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of

Hiroyuki Nishi et al.

Group Art Unit: 1732

Serial No.: 09/893,455

Examiner: A. Ortiz

Filed: June 29, 2001

FOR: TRANSFER MOLDING APPARATUS AND METHOD FOR
MANUFACTURING SEMICONDUCTOR DEVICES

RECEIVED
APR 07 2003
GROUP 1700

RESPONSE TO ELECTION OF SPECIES REQUIREMENT

Honorable Commissioner of
Patents and Trademarks,
Washington, D.C. 20231

Date: April 3, 2003

Sir:

In response to the Election of Species Requirement dated March 11, 2003, the following election, amendments and remarks are respectfully submitted in connection with the above identified application.

In the Abstract

Please cancel the Abstract and replace with the Abstract attached herewith.

In the Specification

Kindly amend the specification as follows:

Page 1, between the title and the heading "BACKGROUND OF THE
INVENTION" insert